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LPV7215

SNOSAI6J-SEPTEMBER 2005-REVISED AUGUST 2016

# LPV7215 Micropower, CMOS Input, RRIO, 1.8-V, Push-Pull Output Comparator

Technical

Documents

# 1 Features

- (For V<sup>+</sup> = 1.8 V, Typical Unless Otherwise Noted)
- Ultra-Low Power Consumption: 580 nA
- Wide Supply Voltage Range: 1.8 V to 5.5 V
- Propagation Delay: 4.5 µs
- Push-Pull Output Current Drive at 5 V 19 mA
- Temperature Range: -40°C to 125°C
- Rail-to-Rail Input
- Tiny 5-Pin SOT-23 and SC70 Packages

# 2 Applications

- RC Timers
- Window Detectors
- IR Receivers
- Multivibrators
- Alarm and Monitoring Circuits

# 3 Description

Tools &

Software

The LPV7215 device is an ultra-low-power comparator with a typical power supply current of 580 nA. It has the best-in-class power supply current versus propagation delay performance available among TI's low-power comparators. The propagation delay is as low as 4.5 µs with 100-mV overdrive at 1.8-V supply.

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Designed to operate over a wide range of supply voltages, from 1.8 V to 5.5 V, with ensured operation at 1.8 V, 2.7 V, and 5 V, the LPV7215 is ideal for use in a variety of battery-powered applications. With rail-to-rail common-mode voltage range, the LPV7215 is well suited for single-supply operation.

Featuring a push-pull output stage, the LPV7215 allows for operation with absolute minimum power consumption when driving any capacitive or resistive load.

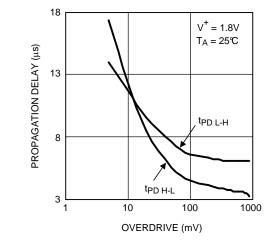
Available in a choice of space-saving packages, the LPV7215 is ideal for use in handheld electronics and mobile phone applications. The LPV7215 is manufactured with TI's advanced VIP50 process.

Device	Inform	ation <sup>(1)</sup>
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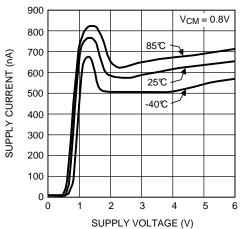
PART NUMBER	PACKAGE	BODY SIZE (NOM)
LPV7215	SOT-23 (5)	2.90 mm × 1.60 mm
	SC70 (5)	2.00 mm × 1.25 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

# **Propagation Delay vs Overdrive**



# Supply Current vs Supply Voltage



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# 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

CI	hanges from Revision I (April 2013) to Revision J	Page
•	Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section	1
•	Updated values in the Thermal Information table to align with JEDEC standards.	4
CI	hanges from Revision H (April 2013) to Revision I	Page

•	Changed layout of National Data Sheet to TI format	. 22
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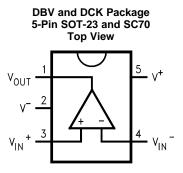
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# 5 Pin Configuration and Functions



#### **Pin Functions**

PIN		I/O	DESCRIPTION		
NO.	NAME	1/0	DESCRIPTION		
1	V <sub>OUT</sub>	0	Output		
2	V-	Р	Negative Supply		
3	VIN+	I	Noninverting Input		
4	VIN–	I	Inverting Input		
5	V <sup>+</sup>	Р	Positive Supply		

# 6 Specifications

# 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

	MIN	MAX	UNIT
V <sub>IN</sub> differential	-2.5	2.5	V
Supply voltage (V <sup>+</sup> - V <sup>-</sup> )		6	V
Voltage at input and output pins	V <sup>-</sup> - 0.3	V <sup>+</sup> + 0.3	V
Junction temperature, $T_{J}^{(2)}$		150	°C
Storage temperature, T <sub>stg</sub>	-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A)/\theta_{JA}$ . All numbers apply for packages soldered directly onto a PCB.

# 6.2 ESD Ratings

				UNIT
V <sub>(</sub> ) Electrostatic discharge	Electroptotic discharge	Human-body model (HBM) <sup>(1)</sup>	±2000	V
	Machine model (MM) <sup>(2)</sup>	±200	V	

(1) Human-body model, applicable std. MIL-STD-883, Method 3015.7.

(2) Machine model, applicable std. JESD22-A115-A (ESD MM std. of JEDEC)Field-Induced Charge-Device Model, applicable std. JESD22-C101-C (ESD FICDM std. of JEDEC). SNOSAI6J-SEPTEMBER 2005-REVISED AUGUST 2016

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# 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	MIN	MAX	UNIT
Temperature <sup>(1)</sup>	-40	125	°C
Supply voltage $(V^+ - V^-)$	1.8	5.5	V

(1) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A)/\theta_{JA}$ . All numbers apply for packages soldered directly onto a PCB.

## 6.4 Thermal Information

		LPV	LPV7215		
	THERMAL METRIC <sup>(1)</sup>	DBV (SOT-23)	DCK (SC70)	UNIT	
		5 PINS	5 PINS		
$R_{\theta JA}$	Junction-to-ambient thermal resistance <sup>(2)</sup>	234	456	°C/W	
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	153	110.8	°C/W	
$R_{\thetaJB}$	Junction-to-board thermal resistance	51.7	59.8	°C/W	
ΨJT	Junction-to-top characterization parameter	38	3.6	°C/W	
ΨЈВ	Junction-to-board characterization parameter	51.2	59	°C/W	
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	n/a	n/a	°C/W	

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

(2) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$ . The maximum allowable power dissipation at any ambient temperature is  $P_D = (T_{J(MAX)} - T_A)/|\theta_{JA}|$ . All numbers apply for packages soldered directly onto a PCB.

# 6.5 Electrical Characteristics: 1.8 V

Unless otherwise specified, all limits are specified for  $T_A = 25^{\circ}C$ ,  $V^+ = 1.8V$ ,  $V^- = 0$  V, and  $V_{CM} = V^+/2$ ,  $V_O = V^-$ .<sup>(1)</sup>

	PARAMETER	TEST C	ONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
			$T_A = 25^{\circ}C$		580	750	
		V <sub>CM</sub> = 0.3 V	Temperature extremes			1050	
I <sub>S</sub>	Supply current		$T_A = 25^{\circ}C$		790	980	nA
		V <sub>CM</sub> = 1.5 V	Temperature extremes			1300	
	Input offset voltage	V <sub>CM</sub> = 0 V	$T_A = 25^{\circ}C$		±0.3	±6	mV
M			Temperature extremes			±8	
V <sub>OS</sub>		V <sub>CM</sub> = 1.8 V	$T_A = 25^{\circ}C$		±0.4	±5	
			Temperature extremes			±7	
TCV <sub>OS</sub>	Input offset average drift	See <sup>(4)</sup>			±1		μV/C
I <sub>B</sub>	Input bias current <sup>(5)</sup>	V <sub>CM</sub> = 1.6 V			-40		fA
I <sub>OS</sub>	Input offset current				10		fA

(1) Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.

(2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlations using statistical quality control (SQC) method.

(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and also depend on the application and configuration. The typical values are not tested and are not specified on shipped production material.

(4) Offset voltage average drift determined by dividing the change in V<sub>OS</sub> at temperature extremes into the total temperature change.

(5) Positive current corresponds to current flowing into the device.

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# Electrical Characteristics: 1.8 V (continued)

Unless otherwise specified, all limits are specified for  $T_A = 25^{\circ}C$ ,  $V^+ = 1.8V$ ,  $V^- = 0$  V, and  $V_{CM} = V^+/2$ ,  $V_O = V^{-.(1)}$ 

	PARAMETER	TEST COM	NDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
		Var. Stopped from	$T_A = 25^{\circ}C$	66	88		
		V <sub>CM</sub> Stepped from 0 V to 0.7 V	Temperature extremes	62			
	Common-mode rejection ratio	V <sub>CM</sub> Stepped from	$T_A = 25^{\circ}C$	68	87		
CMRR		1.2 V to 1.8 V	Temperature extremes	62			dB
		Var. Stoppod from	$T_A = 25^{\circ}C$	44	77		
		V <sub>CM</sub> Stepped from 0 V to 1.8 V	Temperature extremes	43			
		V <sup>+</sup> = 1.8 V to 5.5	$T_A = 25^{\circ}C$	66	82		
PSRR	Power supply rejection ratio	$V, V_{CM} = 0 V$	Temperature extremes	63			dB
CMVR	Input common-mode voltage range	CMRR ≥ 40 dB	Temperature Extremes	-0.1		1.9	V
A <sub>V</sub>	Voltage gain		1		120		dB
			$T_A = 25^{\circ}C$	1.63	1.69		
	Output swing high	I <sub>O</sub> = 500 μA	Temperature extremes	1.58			V
		I <sub>O</sub> = 1 mA	$T_A = 25^{\circ}C$	1.46	1.6		v
Vo			Temperature extremes	1.37			
٧O	Output swing low	500 4	$T_A = 25^{\circ}C$		88	180	
		I <sub>O</sub> = −500 μA	Temperature extremes			230	mV
			$T_A = 25^{\circ}C$		180	310	IIIV
		l <sub>O</sub> = −1 mA	Temperature extremes			400	
		Source V <sub>O</sub> = V <sup>+</sup> /2	$T_A = 25^{\circ}C$	1.75	2.26		
lour			Temperature extremes	1.3			mA
I <sub>OUT</sub>	Output current	Sink	$T_A = 25^{\circ}C$	2.35	3.1		ША
		$V_0 = V^+/2$	Temperature extremes	1.45			
		Overdrive = 10 mV	1		13		
	Propagation delay (high to low)	Overdrive = 100	$T_A = 25^{\circ}C$		4.5	6.5	μs
		mV	Temperature extremes			9	
		Overdrive = 10 mV			12.5		
	Propagation delay (low to high)	Overdrive = 100	$T_A = 25^{\circ}C$		6.6	9	μs
		mV	Temperature extremes			12	
t	Rise time	$\begin{array}{l} \text{Overdrive} = 10 \text{ mV} \\ \text{C}_{\text{L}} = 30 \text{ pF}, \text{ R}_{\text{L}} = 1 \end{array}$			80		ns
t <sub>rise</sub>		$\begin{array}{l} \text{Overdrive} = 100 \text{ m} \\ \text{C}_{\text{L}} = 30 \text{ pF}, \text{ R}_{\text{L}} = 1 \end{array}$	75			ns	
•		$\begin{array}{l} \text{Overdrive} = 10 \text{ mV} \\ \text{C}_{\text{L}} = 30 \text{ pF}, \text{ R}_{\text{L}} = 1 \end{array}$			70		~~
t <sub>fall</sub>	Fall time	Overdrive = 100 m $C_L$ = 30 pF, $R_L$ = 1		65		ns	

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## 6.6 Electrical Characteristics: 2.7 V

Unless otherwise specified, all limits are specified for  $T_A = 25^{\circ}C$ ,  $V^+ = 2.7 \text{ V}$ ,  $V^- = 0 \text{ V}$ , and  $V_{CM} = V^+/2$ ,  $V_O = V^-$ .<sup>(1)</sup>

	PARAMETER	TEST CO	NDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT	
			$T_A = 25^{\circ}C$		605	780		
1	Supply surrent	$V_{CM} = 0.3 V$	Temperature extremes			1100	<b>n</b> (	
I <sub>S</sub>	Supply current		$T_A = 25^{\circ}C$		815	1010	nA	
		V <sub>CM</sub> = 2.4 V	Temperature extremes			1350		
			$T_A = 25^{\circ}C$		±0.3	±6		
M	lanut offect voltage	V <sub>CM</sub> = 0 V	Temperature extremes			±8	m)/	
V <sub>OS</sub>	Input offset voltage		$T_A = 25^{\circ}C$		±0.3	±5	mV	
		V <sub>CM</sub> = 2.7 V	Temperature extremes			±7		
TCV <sub>OS</sub>	Input offset average drift	See (4)			±1		μV/C	
I <sub>B</sub>	Input bias current <sup>(5)</sup>	V <sub>CM</sub> = 1.8 V			-40		fA	
l <sub>os</sub>	Input offset current				20		fA	
		V <sub>CM</sub> Stepped	$T_A = 25^{\circ}C$	72	90			
		from 0 V to 1.6 V	Temperature extremes	66				
		V <sub>CM</sub> Stepped	$T_A = 25^{\circ}C$	71	94			
CMRR	Common-mode rejection ratio	from 2.1V to 2.7V	Temperature extremes	63			dB	
		Vov Stepped	$T_A = 25^{\circ}C$	47	80			
		V <sub>CM</sub> Stepped from 0 V to 2.7 V	Temperature extremes	46				
		V <sup>+</sup> = 1.8 V to 5.5	$T_A = 25^{\circ}C$	66	82			
PSRR	Power supply rejection ratio	V = 1.8 V 10 5.5 V, V <sub>CM</sub> = 0 V	Temperature extremes	63			dB	
CMVR	Input common-mode voltage range	CMRR ≥ 40 dB	Temperature extremes	-0.1		2.8	V	
A <sub>V</sub>	Voltage gain				120		dB	
			$T_A = 25^{\circ}C$	2.57	2.62			
	Output owing high	Ι <sub>Ο</sub> = 500 μΑ	Temperature extremes	2.53			V	
	Output swing high		$T_A = 25^{\circ}C$	2.47	2.53		v	
		$I_{O} = 1 \text{ mA}$	Temperature extremes	2.4				
Vo			$T_A = 25^{\circ}C$		60	130		
	Output swing low	I <sub>O</sub> = -500 μA	Temperature extremes			190	m) (	
	Output swing low		$T_A = 25^{\circ}C$		120	250	mV	
		I <sub>O</sub> = −1 mA	Temperature extremes			330		
				-				

(1) Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.

(2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlations using statistical quality control (SQC) method.

(3) Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and also depend on the application and configuration. The typical values are not tested and are not specified on shipped production material.

(4) Offset voltage average drift determined by dividing the change in V<sub>OS</sub> at temperature extremes into the total temperature change.

(5) Positive current corresponds to current flowing into the device.

# Electrical Characteristics: 2.7 V (continued)

Unless otherwise specified, all limits are specified for  $T_A = 25^{\circ}C$ ,  $V^+ = 2.7 \text{ V}$ ,  $V^- = 0 \text{ V}$ , and  $V_{CM} = V^+/2$ ,  $V_0 = V^{-.(1)}$ 

PARAMETER		TEST CC	NDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
		Source	$T_A = 25^{\circ}C$	4.5	5.7		
	Output surrent	$V_0 = V^+/2$	Temperature extremes	3.4			mA
IOUT	Output current	Sink	$T_A = 25^{\circ}C$	5.6	7.5		ША
		$V_0 = V^+/2$	Temperature extremes	3.2			
		Overdrive = 10 m	V		14.5		
	Propagation delay	Overdrive = 100	$T_A = 25^{\circ}C$		5.8	8.5	
	(high to low)	mV	Temperature extremes			10.5	
		Overdrive = 10 mV			15		μs
	Propagation delay (low to high)	Overdrive 100	$T_A = 25^{\circ}C$	7.5	10		
		Overdrive = 100 mV	Temperature extremes			12.5	
	Distribut	Overdrive = 10 mV $C_{L}$ = 30 pF, $R_{L}$ = 1 M $\Omega$			90		
t <sub>rise</sub>	Rise time	Overdrive = 100 m $C_L = 30 \text{ pF}, R_L = 7$		85		ns	
		Overdrive = 10 mV $C_L = 30 \text{ pF}, R_L = 20$		85		20	
t <sub>fall</sub>	Fall time	Overdrive = 100 m $C_L = 30 \text{ pF}, R_L = 2$		75		ns	

## 6.7 Electrical Characteristics: 5 V

Unless otherwise specified, all limits are specified for  $T_A = 25^{\circ}C$ ,  $V^+ = 5 V$ ,  $V^- = 0 V$ , and  $V_{CM} = V^+/2$ ,  $V_O = V^-$ .<sup>(1)</sup>

	PARAMETER	TEST CO	ONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
			$T_A = 25^{\circ}C$		612	790	
	Cupply surront	V <sub>CM</sub> = 0.3 V	Temperature extremes			1150	-
I <sub>S</sub>	Supply current		$T_A = 25^{\circ}C$		825	1030	nA
		V <sub>CM</sub> = 4.7 V	Temperature extremes			1400	
			$T_A = 25^{\circ}C$		±0.3	±6	
M	Input offset voltage	V <sub>CM</sub> = 0 V	Temperature extremes			±8	
V <sub>OS</sub>			$T_A = 25^{\circ}C$			±5	mV
		V <sub>CM</sub> = 5 V	Temperature extremes			±7	
TCV <sub>OS</sub>	Input offset average drift	See (4)			±1		μV/C
I <sub>B</sub>	Input bias current <sup>(5)</sup>	$V_{CM} = 4.5 V$			-400		fA
I <sub>OS</sub>	Input offset current				20		fA

- (4) Offset voltage average drift determined by dividing the change in V<sub>OS</sub> at temperature extremes into the total temperature change.
- (5) Positive current corresponds to current flowing into the device.

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<sup>(1)</sup> Electrical table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device.

<sup>(2)</sup> Limits are 100% production tested at 25°C. Limits over the operating temperature range are specified through correlations using statistical quality control (SQC) method.

<sup>(3)</sup> Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and also depend on the application and configuration. The typical values are not tested and are not specified on shipped production material.

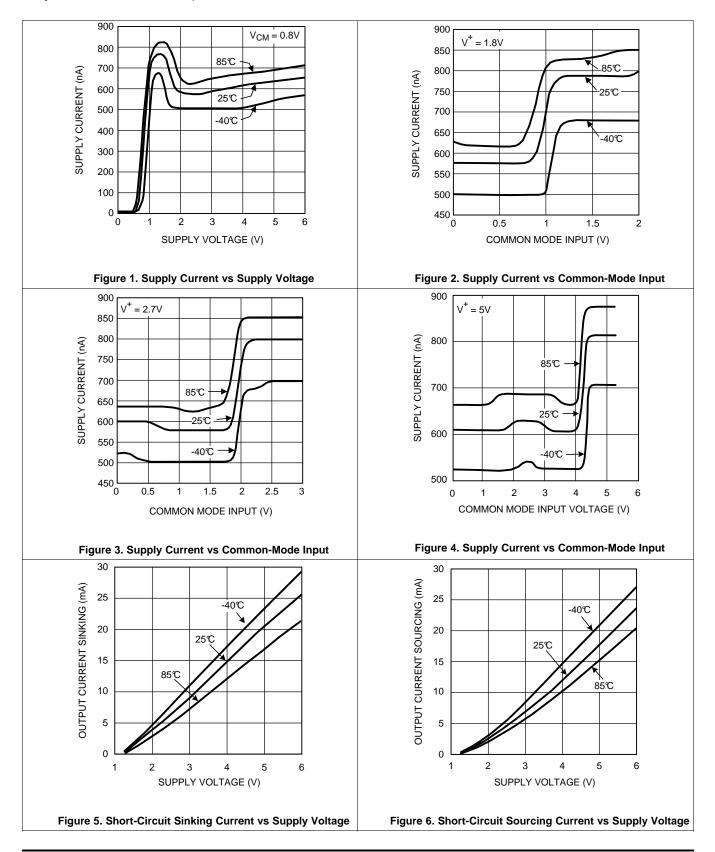
# **Electrical Characteristics: 5 V (continued)**

Unless otherwise specified, all limits are specified for  $T_A = 25^{\circ}C$ ,  $V^+ = 5 V$ ,  $V^- = 0 V$ , and  $V_{CM} = V^+/2$ ,  $V_O = V^-$ . <sup>(1)</sup>

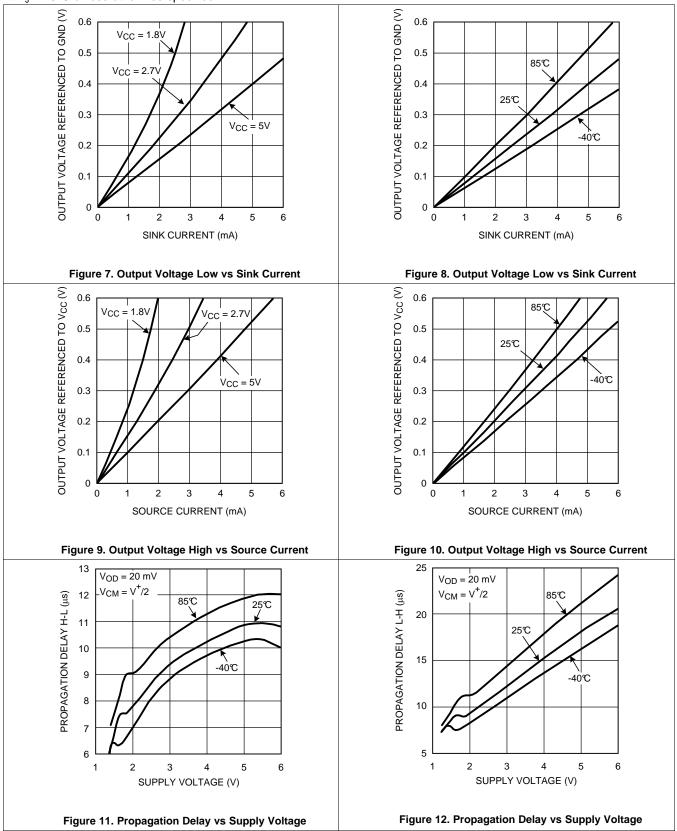
PARAMETER		TEST CON	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT	
		V Stopped from	$T_A = 25^{\circ}C$	72	98		
		V <sub>CM</sub> Stepped from 0 V to 3.9 V	Temperature extremes	66			
	Common-mode rejection ratio	V Stopped from	$T_A = 25^{\circ}C$	73	92		
CMRR		V <sub>CM</sub> Stepped from 4.4 V to 5 V	Temperature extremes	67			dB
		V Stopped from	$T_A = 25^{\circ}C$	53	82		
		V <sub>CM</sub> Stepped from 0 V to 5 V	Temperature extremes	49			
		V <sup>+</sup> = 1.8 V to 5.5	$T_A = 25^{\circ}C$	66	82		
PSRR	Power supply rejection ratio	$V, V_{CM} = 0 V$	Temperature extremes	63			dB
CMVR	Input common-mode voltage range	CMRR ≥ 40 dB	Temperature extremes	-0.1		5.1	V
A <sub>V</sub>	Voltage gain				120		dB
			$T_A = 25^{\circ}C$	4.9	4.94		
Vo	Output swing high	I <sub>O</sub> = 500 μA	Temperature extremes	4.86			V
		I <sub>O</sub> = 1 mA	$T_A = 25^{\circ}C$	4.82	4.89		v
			Temperature extremes	4.77			
	Output swing low	I <sub>O</sub> = -500 μA	$T_A = 25^{\circ}C$		43	90	
			Temperature extremes			130	mV
			$T_A = 25^{\circ}C$		88	170	IIIV
		I <sub>O</sub> = −1 mA	Temperature extremes			230	
		Source	$T_A = 25^{\circ}C$	13	17		
المربع	Output comment	$V_0 = V^+/2$	Temperature extremes	7.5			mA
I <sub>OUT</sub>	Output current	Sink	$T_A = 25^{\circ}C$	14.5	19		ШA
		$V_0 = V^+/2$	Temperature extremes	8.5			
		Overdrive = 10 mV			18		μs
	Propagation delay	Overdrive = 100	T <sub>A</sub> = 25°C		7.7	13.5	
	(high to low)	mV	Temperature extremes			16	
		Overdrive = 10 mV			30		μs
	Propagation delay (low to high)	Overdrive = 100	$T_A = 25^{\circ}C$		12	15	
		mV	Temperature extremes			20	
tuine	Rise time	$\begin{array}{l} \text{Overdrive} = 10 \text{ mV} \\ \text{C}_{\text{L}} = 30 \text{ pF}, \text{ R}_{\text{L}} = 1 \end{array}$	MΩ		100		ns
t <sub>rise</sub>		$\label{eq:constraint} \begin{array}{l} \text{Overdrive} = 100 \text{ mV} \\ \text{C}_{\text{L}} = 30 \text{ pF}, \text{ R}_{\text{L}} = 1 \text{ M}\Omega \end{array}$			100		110
t	Fall time	Overdrive = 10 mV $C_L = 30 \text{ pF}, R_L = 1$			115		ne
t <sub>fall</sub>			Overdrive = 100 mV $C_L$ = 30 pF, $R_L$ = 1 M $\Omega$				ns



# 6.8 Typical Characteristics

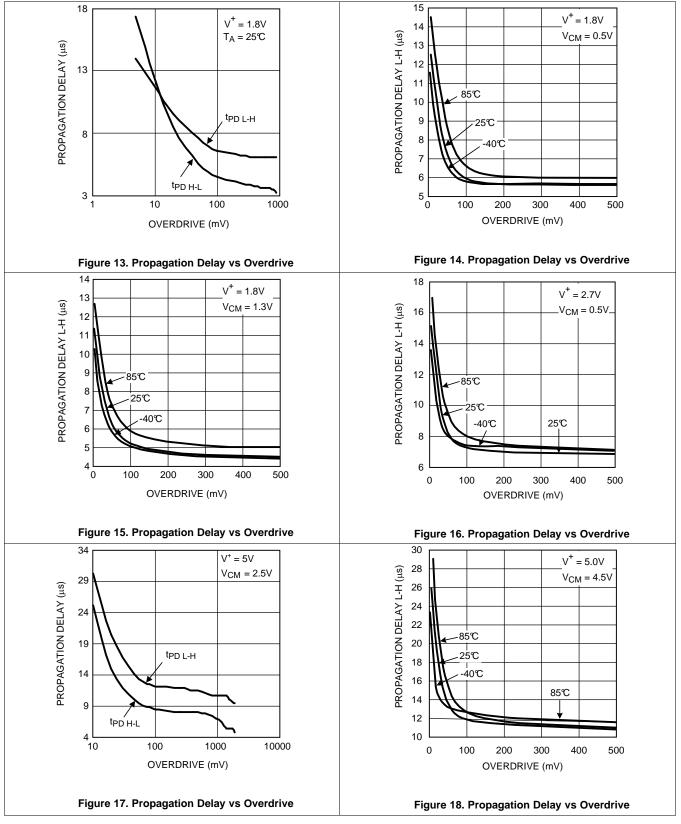


# **Typical Characteristics (continued)**

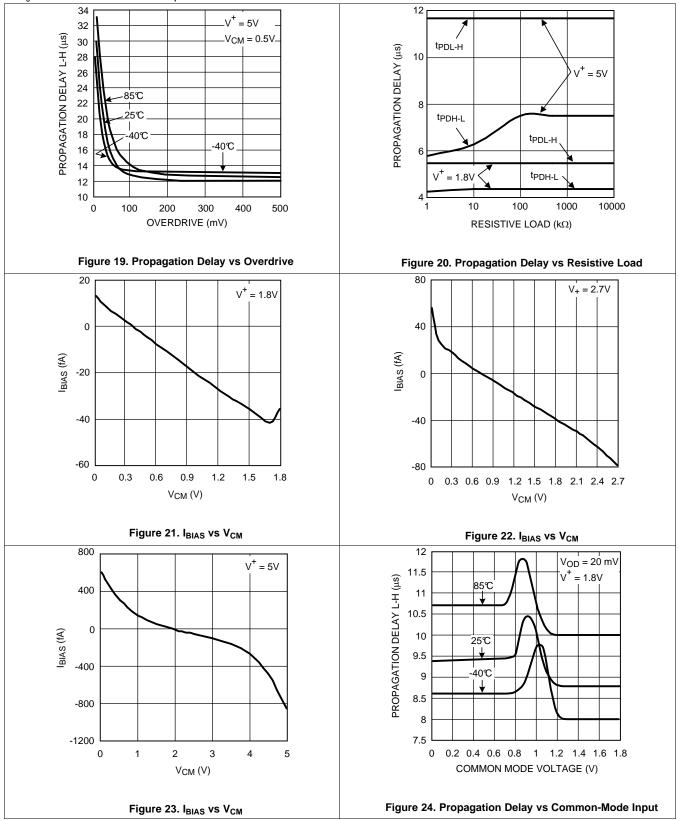




# **Typical Characteristics (continued)**

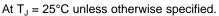


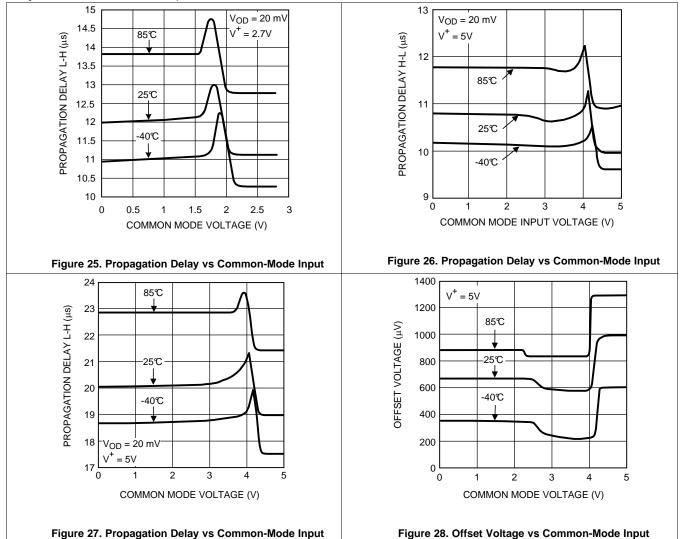
# **Typical Characteristics (continued)**





# **Typical Characteristics (continued)**





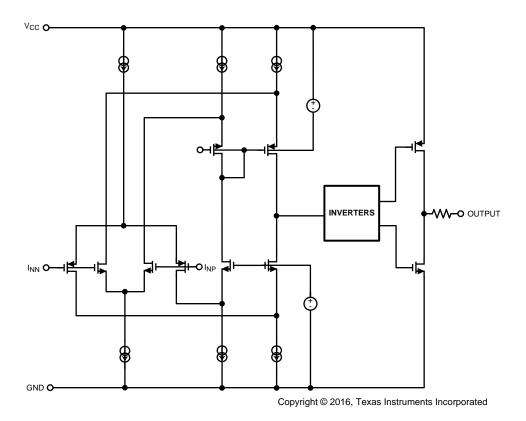


# 7 Detailed Description

# 7.1 Overview

The LPV7215 is a single-channel comparator with a push-pull output stage. This comparator is optimized for low-power consumption and single-supply operation with greater than rail-to-rail input operation. The push-pull output of the LPV7215 supports rail-to-rail output swing and interfaces with TTL/CMOS logic.

# 7.2 Functional Block Diagram



# 7.3 Feature Description

Low supply current and fast propagation delay distinguish the LPV7215 from other low-power comparators.

# 7.3.1 Input Stage

The LPV7215 has rail-to-rail input common-mode voltage range. It can operate at any differential input voltage within this limit as long as the differential voltage is greater than zero. A differential input of zero volts may result in oscillation.

The differential input stage of the comparator is a pair of PMOS and NMOS transistors, therefore, no current flows into the device. The input bias current measured is the leakage current in the MOS transistors and input protection diodes. This low bias current allows the comparator to interface with a variety of circuitry and devices with minimal concern about matching the input resistances.

The input to the comparator is protected from excessive voltage by internal ESD diodes connected to both supply rails. This protects the circuit from both ESD events, as well as signals that significantly exceed the supply voltages. When this occurs the ESD protection diodes becomes forward-biased and draws current into these structures, resulting in no input current to the terminals of the comparator. Until this occurs, there is essentially no input current to the diodes. As a result, placing a large resistor in series with an input that may be exposed to large voltages, limits the input current but have no other noticeable effect.



## Feature Description (continued)

## 7.3.2 Output Stage

The LPV7215 has a MOS push-pull rail-to-rail output stage. The push-pull transistor configuration of the output keeps the total system power consumption to a minimum. The only current consumed by the LPV7215 is the less than 1- $\mu$ A supply current and the current going directly into the load. No power is wasted through the pullup resistor when the output is low. The output stage is specifically designed with dead time between the time when one transistor is turned off and the other is turned on (break-before-make) to minimize shoot through currents. The internal logic controls the break-before-make timing of the output transistors. The break-before-make delay varies with temperature and power condition.

## 7.3.3 Output Current

Even though the LPV7215 uses less than 1-µA supply current, the outputs are able to drive very large currents. The LPV7215 can source up to 17 mA and can sink up to 19 mA, when operated at 5-V supply. This large current handling capability allows driving heavy loads directly.

## 7.3.4 Response Time

Depending upon the amount of overdrive, the propagation delay is typically 6 to 30 µs. The curves showing propagation delay vs overdrive in the *Typical Characteristics* section shows the delay time when the input is preset with 100 mV across the inputs and then is driven the other way by 10 mV to 500 mV.

The output signal can show a step during switching depending on the load. A fast RC time constant due to both small capacitive and resistive loads shows a significant step in the output signal. A slow RC time constant due to either a large resistive or capacitive load has a clipped corner on the output signal. The step is observed more prominently during a falling transition from high to low.

The plot in Figure 29 shows the output for single 5-V supply with a 100-k $\Omega$  resistor. The step is at 1.3 V.

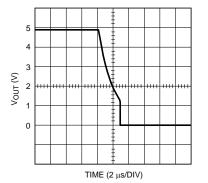


Figure 29. Output Signal Without Capacitive Load

The plot in Figure 30 shows the output signal when a 20-pF capacitor is added as a load. The step is at about 2.5 V.

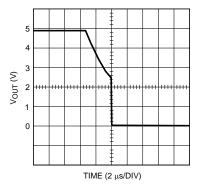


Figure 30. Output Signal With 20-pF Load



## 7.4 Device Functional Modes

## 7.4.1 Capacitive and Resistive Loads

The propagation delay is not affected by capacitive loads at the output of the LPV7215. However, resistive loads slightly affect the propagation delay on the falling edge by a reduction of almost 2 µs depending on the load resistance value.

## 7.4.2 Noise

Most comparators have rather low gain. This allows the output to spend time between high and low when the input signal changes slowly. The result is that the output may oscillate between high and low when the differential input is near zero. The exceptionally high gain of this comparator, 120 dB, eliminates this problem. Less than 1  $\mu$ V of change on the input drives the output from one rail to the other rail. If the input signal is noisy, the output cannot ignore the noise unless some hysteresis is provided by positive feedback (see *Hysteresis*).

## 7.4.3 Hysteresis

To improve propagation delay when low overdrive is needed, hysteresis can be added.

## 7.4.4 Inverting Comparator With Hysteresis

The inverting comparator with hysteresis requires a three resistor network that is referenced to the supply voltage V<sup>+</sup> of the comparator as shown in Figure 31. When V<sub>IN</sub> at the inverting input is less than V<sub>A</sub>, the voltage at the noninverting node of the comparator (V<sub>IN</sub> < V<sub>A</sub>), the output voltage is high (for simplicity assume V<sub>O</sub> switches as high as V<sup>+</sup>). The three network resistors can be represented as R<sub>1</sub>//R<sub>3</sub> in series with R<sub>2</sub>.

The lower input trip voltage  $V_{A1}$  is defined as Equation 1.

$$V_{A1} = V_{CC}R_2 / ((R_1 / / R_3) + R_2)$$
(1)

When  $V_{IN}$  is greater than  $V_A$ , the output voltage is low or very close to ground. In this case the three network resistors can be presented as  $R_2//R_3$  in series with  $R_1$ .

The upper trip voltage  $V_{A2}$  is defined as Equation 2.

$$V_{A2} = V_{CC} (R_2 / / R_3) / ((R_1 + (R_2 / / R_3)))$$

The total hysteresis provided by the network is defined as  $\Delta V_A = V_{A1} - V_{A2}$ , as shown in Equation 3.

$$\Delta V_{A} = \frac{+V_{CC}R_{1}R_{2}}{R_{1}R_{2} + R_{1}R_{3} + R_{2}R_{3}}$$

(3)

(2)



## **Device Functional Modes (continued)**

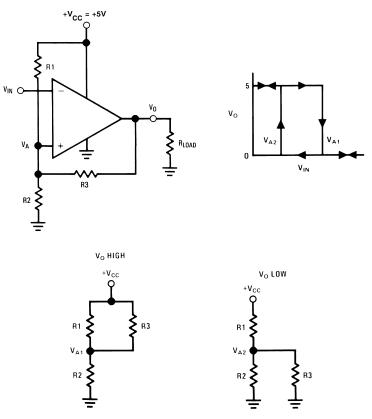


Figure 31. Inverting Comparator With Hysteresis

## 7.4.5 Noninverting Comparator With Hysteresis

A noninverting comparator with hysteresis requires a two resistor network, and a voltage reference ( $V_{REF}$ ) at the inverting input. When  $V_{IN}$  is low, the output is also low. For the output to switch from low to high,  $V_{IN}$  must rise up to  $V_{IN1}$  where  $V_{IN1}$  is calculated by Equation 4.

$$V_{\rm IN1} = \frac{V_{\rm REF}(R_1 + R_2)}{R_2}$$
(4)

As soon as  $V_O$  switches to  $V_{CC}$ ,  $V_A$  steps to a value greater than  $V_{REF}$ , which is given by Equation 5.

$$V_{A} = V_{IN} + \frac{(V_{CC} - V_{IN1})R_{1}}{R_{1} + R_{2}}$$
<sup>(5)</sup>

To make the comparator switch back to its low state,  $V_{IN}$  must equal  $V_{REF}$  before  $V_A$  again equals  $V_{REF}$ .  $V_{IN2}$  can be calculated by Equation 6.

$$V_{\rm IN2} = \frac{V_{\rm REF}(R_1 + R_2) - V_{\rm CC} R_1}{R_2}$$
(6)

The hysteresis of this circuit is the difference between  $V_{IN1}$  and  $V_{IN2}$ , as shown in Equation 7.

 $\Delta V_{IN} = V_{CC}R_1/R_2$ 

(7)



## **Device Functional Modes (continued)**

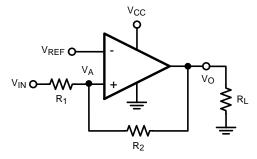


Figure 32. Noninverting Comparator With Hysteresis

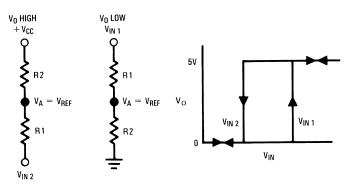


Figure 33. Noninverting Comparator With Hysteresis

## 7.4.6 Zero Crossing Detector

In a zero crossing detector circuit, the inverting input is connected to ground and the noninverting input is connected to a 100-mV<sub>PP</sub> AC signal. As the signal at the noninverting input crosses 0 V, the comparator's output changes state.

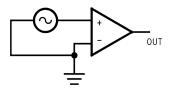


Figure 34. Zero Crossing Detector

To improve switching times and to center the input threshold to ground a small amount of positive feedback is added to the circuit. The voltage divider,  $R_4$  and  $R_5$ , establishes a reference voltage,  $V_1$ , at the positive input. By making the series resistance,  $R_1$  plus  $R_2$  equal to  $R_5$ , the switching condition,  $V_1 = V_2$ , is satisfied when  $V_{IN} = 0$ . The positive feedback resistor,  $R_6$ , is made very large with respect to  $R_5$  ( $R_6 = 2000 R_5$ ). The resultant hysteresis established by this network is very small ( $\Delta V_1 < 10 \text{ mV}$ ) but it is sufficient to insure rapid output voltage transitions. Diode  $D_1$  is used to insure that the inverting input terminal of the comparator never goes below approximately -100 mV. As the input terminal goes negative,  $D_1$  will forward bias, clamping the node between  $R_1$  and  $R_2$  to approximately -700 mV. This sets up a voltage divider with  $R_2$  and  $R_3$  preventing  $V_2$  from going below ground. The maximum negative input overdrive is limited by the current handling ability of  $D_1$ .



# **Device Functional Modes (continued)**

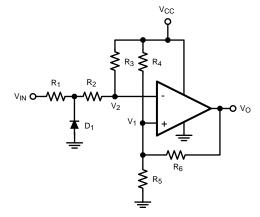


Figure 35. Zero Crossing Detector With Positive Feedback

## 7.4.7 Threshold Detector

Instead of tying the inverting input to 0 V, the inverting input can be tied to a reference voltage. As the input on the noninverting input passes the  $V_{REF}$  threshold, the comparator's output changes state. It is important to use a stable reference voltage to ensure a consistent switching point.

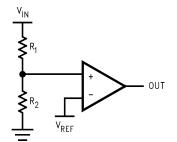


Figure 36. Threshold Detector

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# 8 Application and Implementation

### NOTE

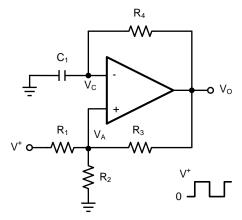
Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

## 8.1 Application Information

The LPV7215 is an ultra-low-power comparator with a typical power supply current of 580 nA. It has the best-inclass power supply current versus propagation delay performance available among TI's low-power comparators. The propagation delay is as low as 4.5 µs with 100-mV overdrive at 1.8-V supply.

## 8.2 Typical Applications

## 8.2.1 Square Wave Generator



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### Figure 37. Square Wave Generator Schematic

## 8.2.1.1 Design Requirements

A typical application for a comparator is as a square wave oscillator. The circuit in Figure 38 generates a square wave whose period is set by the RC time constant of the capacitor  $C_1$  and resistor  $R_4$ . The maximum frequency is limited by the large signal propagation delay of the comparator and by the capacitive loading at the output, which limits the output slew rate.

## 8.2.1.2 Detailed Design Procedure

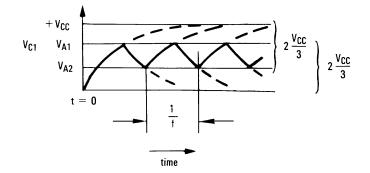


Figure 38. Square Wave Oscillator



## **Typical Applications (continued)**

Consider the output of Figure 38 to be high to analyze the circuit. That implies that the inverted input ( $V_c$ ) is lower than the noninverting input ( $V_A$ ). This causes the C<sub>1</sub> to be charged through R<sub>4</sub>, and the voltage V<sub>C</sub> increases until it is equal to the noninverting input. The value of V<sub>A</sub> at this point is in Equation 8.

$$V_{A1} = \frac{V_{CC} \times R_2}{R_2 + R_1 \parallel R_3}$$
(8)

If  $R_1 = R_2 = R_3$  then  $V_{A1} = 2 V_{CC}/3$ 

At this point the comparator switches pulling down the output to the negative rail. The value of  $V_A$  at this point, as shown in Equation 9:

$$V_{A2} = \frac{V_{CC}(R_2 || R_3)}{R_1 + (R_2 || R_3)}$$
<sup>(9)</sup>

If  $R_1 = R_2 = R_3$  then  $V_{A2} = V_{CC}/3$ 

The capacitor  $C_1$  now discharges through  $R_4$ , and the voltage  $V_C$  decreases until it is equal to  $V_{A2}$ , at which point the comparator switches again, bringing it back to the initial stage. The time period is equal to twice the time it takes to discharge  $C_1$  from 2  $V_{CC}/3$  to  $V_{CC}/3$ , which is given by  $R_4C_1 \times ln2$ . Hence the formula for the frequency is given by Equation 10:

$$F = 1/(2 \times R_4 \times C_1 \times \ln 2)$$

(10)

## 8.2.1.3 Application Curves

Figure 39 shows the simulated results of an oscillator using the following values:

- 1.  $R_1 = R_2 = R_3 = R_4 = 100 \text{ k}\Omega$
- 2.  $C_1 = 100 \text{ pF}, C_1 = 20 \text{ pF}$
- 3. V+ = 5 V, V- = GND
- 4.  $C_{STRAY}$  (not shown) from V<sub>a</sub> to GND = 10 pF

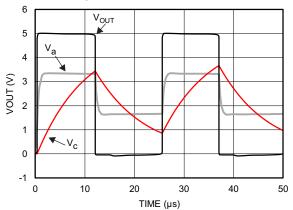


Figure 39. Square Wave Oscillator Output Waveform

# **Typical Applications (continued)**

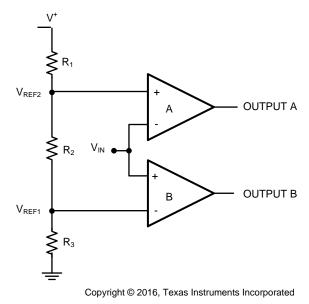
## 8.2.2 Window Detector

A window detector monitors the input signal to determine if it falls between two voltage levels.

The comparator outputs A and B are high only when  $V_{REF1} < V_{IN} < V_{REF2}$  or *within the window*. These are defined as:

$$V_{REF1} = R_3 / (R_1 + R_2 + R_3) \times V^+$$
(11)  
$$V_{REF2} = (R_2 + R_3) / (R_1 + R_2 + R_3) \times V^+$$
(12)

Others names for window detectors are: threshold detector, level detectors, and amplitude trigger or detector.





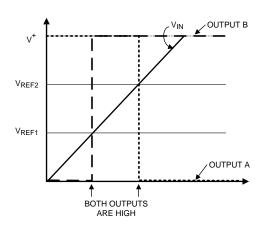


Figure 41. Window Detector Output Signal



## **Typical Applications (continued)**

## 8.2.3 Crystal Oscillator

A simple crystal oscillator using the LPV7215 is shown in Figure 42. Resistors  $R_1$  and  $R_2$  set the bias point at the comparator's noninverting input. Resistors,  $R_3$  and  $R_4$  and capacitor  $C_1$  set the inverting input node at an appropriate DC average level based on the output. The crystal's path provides resonant positive feedback and stable oscillation occurs. The output duty cycle for this circuit is roughly 50%, but it is affected by resistor tolerances and to a lesser extent by the comparator offset.

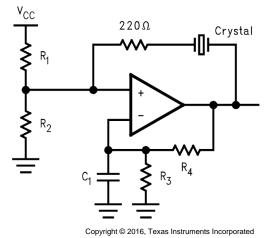


Figure 42. Crystal Oscillator

### 8.2.4 IR Receiver

The LPV7215 can also be used as an infrared receiver. The infrared photo diode creates a current relative to the amount of infrared light present. The current creates a voltage across  $R_D$ . When this voltage level crosses the voltage applied by the voltage divider to the inverting input, the output transitions.

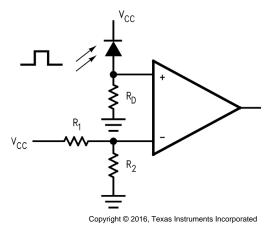


Figure 43. IR Receiver



# 9 Power Supply Recommendations

Comparators are very sensitive to input noise. To minimize supply noise, power supplies must be capacitively decoupled by a 0.01-µF ceramic capacitor in parallel with a 10-µF electrolytic capacitor.

# 10 Layout

## **10.1 Layout Guidelines**

Proper grounding and the use of a ground plane help ensure the specified performance of the LPV7215. Minimizing trace lengths, reducing unwanted parasitic capacitance and using surface-mount components also helps.

## 10.2 Layout Example

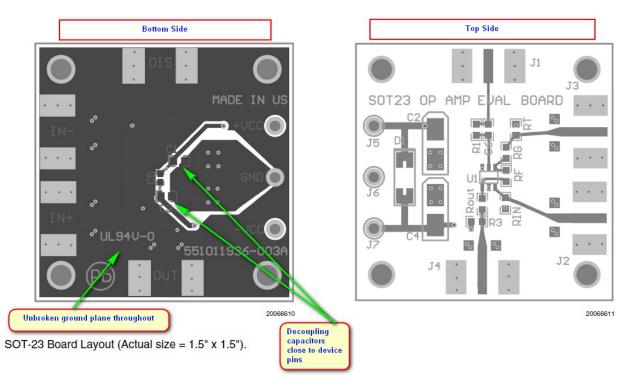


Figure 44. LPV7215 Layout Example



# **11** Device and Documentation Support

# **11.1 Device Support**

## 11.1.1 Development Support

TINA-TI SPICE-Based Analog Simulation Program, http://www.ti.com/tool/tina-ti

DIP Adapter Evaluation Module, http://www.ti.com/tool/dip-adapter-evm

TI Universal Operational Amplifier Evaluation Module, http://www.ti.com/tool/opampevm

## 11.1.2 Documentation Support

### 11.1.2.1 Related Documentation

For related documentation, see the following AN-74 - A Quad of Independently Functioning Comparators (SNOA654).

## 11.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

## **11.3 Community Resources**

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E<sup>™</sup> Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

## 11.4 Trademarks

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

## 11.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

# 11.6 Glossary

#### SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



# PACKAGING INFORMATION

Orderable Device	Status	Package Type	•	Pins	•	Eco Plan	Lead finish/	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	Ball material	(3)		(4/5)	
							(6)				
LPV7215MF/NOPB	ACTIVE	SOT-23	DBV	5	1000	RoHS & Green	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 125	C30A	Samples
LPV7215MFX/NOPB	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	NIPDAU   SN	Level-1-260C-UNLIM	-40 to 125	C30A	Samples
LPV7215MG/NOPB	ACTIVE	SC70	DCK	5	1000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 125	C37	Samples
LPV7215MGX/NOPB	ACTIVE	SC70	DCK	5	3000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 125	C37	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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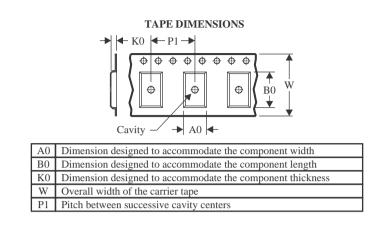


Texas

STRUMENTS

# TAPE AND REEL INFORMATION





### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

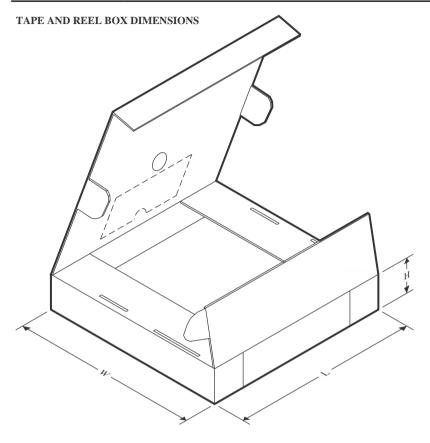


*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LPV7215MF/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LPV7215MFX/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LPV7215MFX/NOPB	SOT-23	DBV	5	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LPV7215MG/NOPB	SC70	DCK	5	1000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LPV7215MGX/NOPB	SC70	DCK	5	3000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3



# PACKAGE MATERIALS INFORMATION

19-Oct-2024



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LPV7215MF/NOPB	SOT-23	DBV	5	1000	208.0	191.0	35.0
LPV7215MFX/NOPB	SOT-23	DBV	5	3000	208.0	191.0	35.0
LPV7215MFX/NOPB	SOT-23	DBV	5	3000	210.0	185.0	35.0
LPV7215MG/NOPB	SC70	DCK	5	1000	208.0	191.0	35.0
LPV7215MGX/NOPB	SC70	DCK	5	3000	208.0	191.0	35.0

# **DCK0005A**



# **PACKAGE OUTLINE**

# SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
   This drawing is subject to change without notice.
   Reference JEDEC MO-203.

- 4. Support pin may differ or may not be present.5. Lead width does not comply with JEDEC.
- 6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



# **DCK0005A**

# **EXAMPLE BOARD LAYOUT**

# SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

Publication IPC-7351 may have alternate designs.
 Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DCK0005A

# **EXAMPLE STENCIL DESIGN**

# SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

10. Board assembly site may have different recommendations for stencil design.



# **DBV0005A**



# **PACKAGE OUTLINE**

# SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
   This drawing is subject to change without notice.
   Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



# DBV0005A

# **EXAMPLE BOARD LAYOUT**

# SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DBV0005A

# **EXAMPLE STENCIL DESIGN**

# SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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